

Harvatek Surface Mount CHIP LEDs Data Sheet B3CQ3RBG-02DX001H4U1930



DISCLAIMER	3
LIFE SUPPORT POLICY	3
PRODUCT SPECIFICATIONS	4
ATTENTION: ELECTROSTATIC DISCHARGE (ESD) PROTECTION	4
LABEL SPECIFICATIONS	5
SPECIFICATIONS RANGE	6
PRODUCT FEATURES	8
ELECTRO-OPTICAL CHARACTERISTICS PACKAGE OUTLINE DIMENSION AND RECOMMENDED SOLDERING PATTERN FOR REFLOW	8
Soldering	8
ABSOLUTE MAXIMUM RATINGS	-
CHARACTERISTICS OF B3CQ3RBG	.10
PRECAUTION FOR USE	.11
PACKAGING	.12
TAPE DIMENSION	.12
REEL DIMENSION	.13
PACKING	.13
DRY PACK	.14
BAKING	.14
PRECAUTIONS	.15
REFLOW SOLDERING	.15
Reworking	.16
Revise History	.17

Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.	Data Sheet No.	
Tentative Product	****	******		
	to changes for improvement without ata, drawings, company confidential	07/07/2023	Rev. 1	Page 2/17

DISCLAIMER

HARVATEK reserves the right to make changes without further notice to any products herein to improve reliability, function or design. HARVATEK does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under its patent rights, nor the rights of others.

Life Support Policy

HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.	Data Sheet No.	
Tentative Product	****	*****		
	to changes for improvement without v data, drawings, company confidential	07/07/2023	Rev. 1	Page 3/17



Product Specifications

	Specification	Material	Quantity
Luminous	White:244.5~450 mcd		
Intensity(Iv)	R/G/B@2mA/ Ts= 25 $^{\circ}$ C ; Tolerance ±10%		
Chromaticity	AS page 7~8		
Coordinate	R/G/B@2mA/ Ts= 25 $^\circ$ C ;Tolerance ± 0.007		
Vf	Red : 2.4 V maximum		
	Green :3.1 V maximum		
	Blue : 3.1V maximum		
	R/G/B@2mA/ Ts= 25 $^\circ$ C ;Tolerance ± 0.05V		
Ir	<10µA @-5V		
НВМ	2KV(R/G/B)		
Resin	Diffused	Ероху	
Carrier tape	EIA 481-1A specs	Conductive black tape	4000pcs/reel
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	250x230mm	Aluminum laminated	One reel per bag
		bag/Zipper	
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin

combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label.

Note :This is shipped test conditions

※Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlGaInP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be

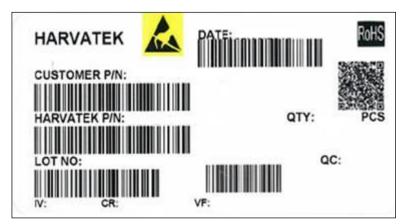
taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.	Data Sheet No.	
Tentative Product	****	*****		
	to changes for improvement without v data, drawings, company confidential	07/07/2023	Rev. 1	Page 4/17



Label Specifications



■Harvatek P/N:

B 3CQ 3 RBG- 02D- X001 H4

Product	Package size	Dice Q'ty	Color	Current	Series Number	Taping
B:PCB	0.95(L) x 0.95(W) x 0.25(H) mm	3:TRI	RBG(Full color)	R/G/B:2mA	X001~XZZZ	1.Taping style
				D:Diffused		2. Q'ty

Lot No.

1	2	3	4	5	6	7	8	9	10
E	1	Α	1	Α	2	2	L	1	2
Cod	de 1 2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number		Special cod	e
Internal Tr	racing Code	2020-L 2021-M 2022-P 2023-Q 2026-T 2027-V 2030-Y 2031-Z 	1:Jan. 2:Feb. A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C 26:Z 27:7 28:8 29:9 30:3 31:4	01-	-ZZ		000-ZZZ	

Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.	Data Sheet No.	
Tentative Product	******	*****		
	to changes for improvement without v data, drawings, company confidential	07/07/2023	Rev. 1	Page 5/17

Specifications Range

Luminous Intensity (Iv) Bin:R/G/B @2mA

Color	Color Bin Code		ΜΑΧ	Condition
	Sc	244.5	285	R: IF=2mA
White	т	285	360	G: IF=2mA
	U	360	450	B: IF=2mA

Note: It maintains a tolerance of ±10% on Luminous Intensity

Color Bin:

Color	Bin	CIE_x /		Bin			Bin			Bin			
COIDI	Code		CIL_y	Code	CIE_x / CIE_y		Code	CIE_x / CIE_y		Code		CIE_x / CIE_y	
		0.24	0.24		0.24	0.26		0.24	0.28		0.22	0.30	
	W9	0.24	0.26	W10	0.24	0.28	W11	0.24	0.30	W12	0.24	0.30	
	VV 3	0.22	0.26	VV10	0.22	0.28	~~	0.22	0.30	VV12	0.24	0.32	
		0.22	0.24		0.22	0.26		0.22	0.28		0.22	0.32	
		0.26	0.24	W14	0.26	0.26	W15	0.26	0.28	W16	0.24	0.30	
		0.26	0.26		0.26	0.28		0.26	0.30		0.26	0.30	
White	**15	0.24	0.26	**14	0.24	0.28		0.24	0.30		0.26	0.32	
		0.24	0.24		0.24	0.26		0.24	0.28		0.24	0.32	
		0.28	0.24		0.28	0.26		0.28	0.28		0.26	0.30	
	W17	0.28	0.26	W18	0.28	0.28	W19	0.28	0.30	W20	0.28	0.30	
	VV 1 /	0.26	0.26	VV 10	0.26	0.28	VV 19	0.26	0.30	VV 20	0.28	0.32	
		0.26	0.24		0.26	0.26		0.26	0.28		0.26	0.32	

Note: It maintains a tolerance of x,y ±0.007

Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.	Data Sheet No.	
Tentative Product	****	******		
	to changes for improvement without v data, drawings, company confidential	07/07/2023	Rev. 1	Page 6/17



CIE Chromaticity Diagram



Forward Voltage (Vf) Bin:

	HT-B3CQ3RBG Series									
Vf										
	Red Green Blue									
E18 1.6 2.4 F2A 2.1 3.1 F2A 2.1 3.1								3.1		

Note: It maintains a tolerance of $\pm 0.05V$ on forward voltage measurements

Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.		Data Sheet No.
Tentative Product	****	*****		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/07/2023	Rev. 1	Page 7/17

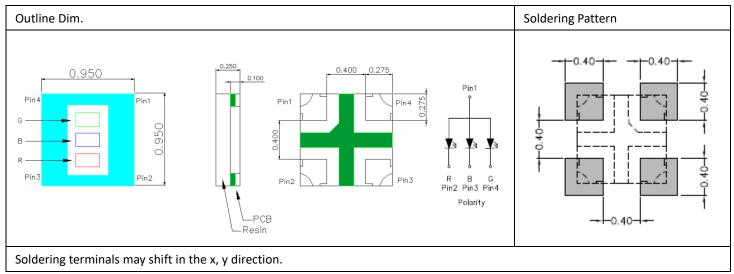


Product Features

Electro-Optical Characteristics							
Part number	Emitting Color		ward ge(VF)	Wavelength (nm)	IV(mcd)	T _{Soldering} , 25℃) Viewing Angle 2θ1/2	
		typ.	max.				
	Red	2.0	2.4	\A/bita		5 1 20 de a	
B3CQ3RBG	Green	2.5	3.1	White	244.5~450	>120 deg.	
	Blue	2.7	3.1				

Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

Unit: mm Tolerance: +/-0.1



Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.		Data Sheet No.
Tentative Product	****	*****		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/07/2023	Rev. 1	Page 8/17



Absolute Maximum Ratings

					1 3
Series	P _D (mW)	I _F (mA)	IFP (mA)	т _{ор} (°С)	T₅т (°C)
Color	Power Dissipation	n Forward Current	Discussion Francisco Data Francisco Compaña	Operation	Storage
COIOT	Power Dissipation		Pulse Forward Current	Temperature	Temperature
Red	4.8	2	60	-30~+80	-40~+85
Blue/Green	6.2	2	60	-30 +80	-40 +85

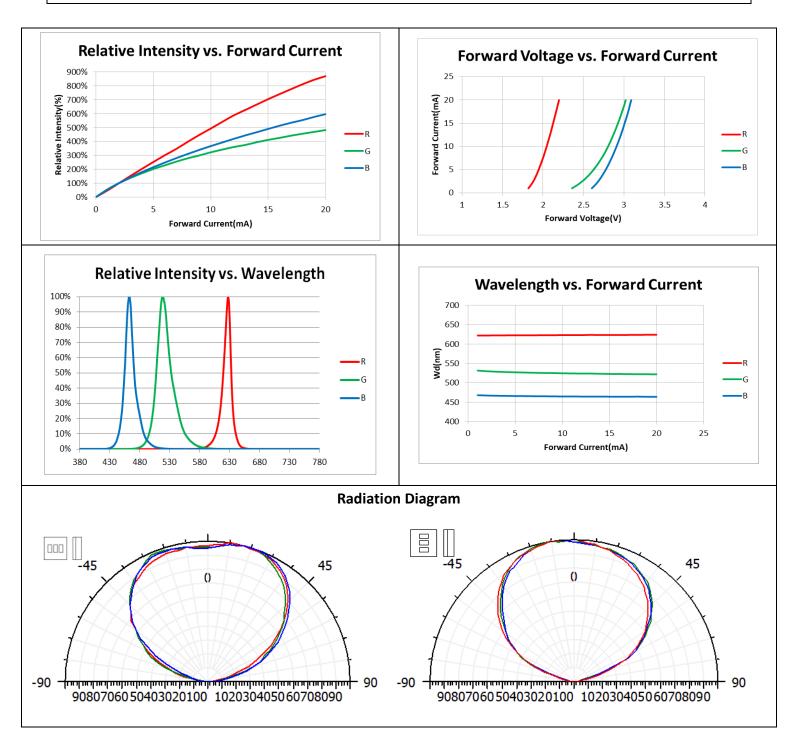
*Condition for $I_{\mbox{\scriptsize FP}}$ is pulse of 1/10 duty and 0.1msec width

*Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.		Data Sheet No.
Tentative Product	*****	*****		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/07/2023	Rev. 1	Page 9/17



Characteristics of B3CQ3RBG



Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.		Data Sheet No.
Tentative Product	*****	*****		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/07/2023	Rev. 1	Page 10/17



Precaution for Use

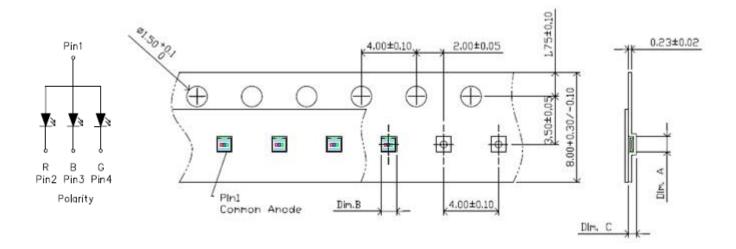
- 1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
- 2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
- 3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
- 4. The LEDs must be used within seven days after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
- 5. The appearance and specifications of the products may be modified for improvement without further notice.
- 6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.		Data Sheet No.
Tentative Product	****	*****		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/07/2023	Rev. 1	Page 11/17



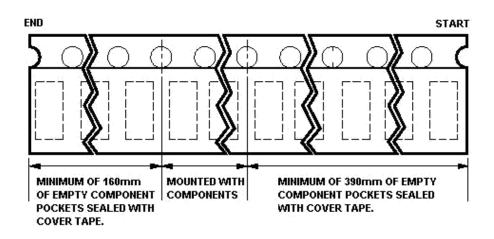
Packaging

Tape Dimension



Dim. A	Dim. B	Dim. C	Q'ty/Reel
1.11±0.05	1.11±0.05	0.35±0.05	4K

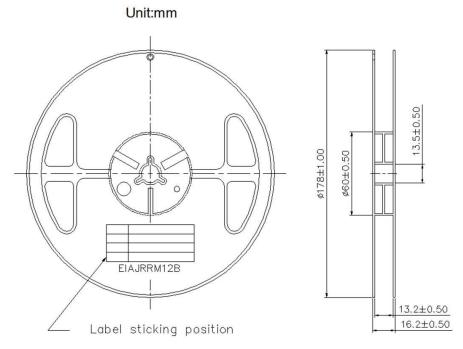
Unit: mm



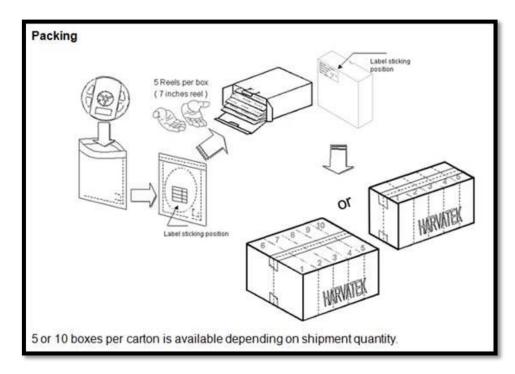
Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.		Data Sheet No.
Tentative Product	*****	*****		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/07/2023	Rev. 1	Page 12/17



Reel Dimension



Packing



5 or 10 boxes per carton is available depending on shipment quantity.

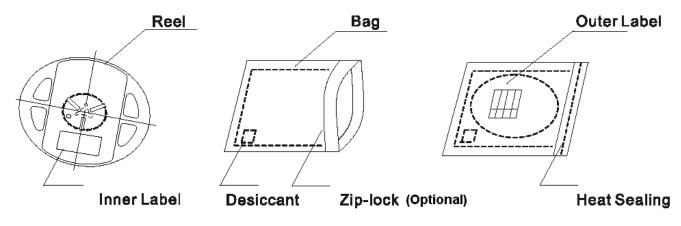
Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.		Data Sheet No.
Tentative Product	****	*****		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/07/2023	Rev. 1	Page 13/17

Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 4 weeks.

The conditions are as followings:

 $60\pm3^{\circ}C \times (12^{\sim}24hrs)$ and <5%RH, taped reel type.

 $100\pm3^{\circ}C \times (45 \text{min}^{-1}\text{hr})$, bulk type.

 $130\pm3^{\circ}C \times (15 \text{min}^{\sim}30 \text{min})$, bulk type.

Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.		Data Sheet No.
Tentative Product	****	*****		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/07/2023	Rev. 1	Page 14/17

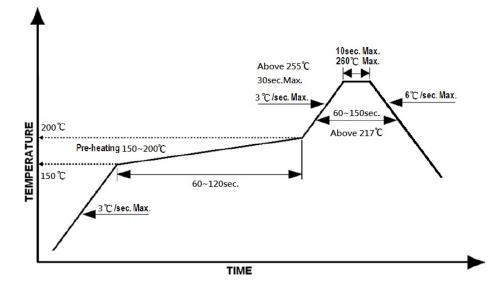
PRECAUTIONS

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlGaInP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

Reflow Soldering

Recommend soldering paste specifications:

- 1. Operating temp.: Above 217° C, 60 ~ 150 sec.
- 2. Peak temp.:260°C Max. 10 sec Max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following: Lead free solder profile





Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.		Data Sheet No.
Tentative Product	******	*****		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/07/2023	Rev. 1	Page 15/17



Reworking

- Rework should be completed within 5 seconds under 260° C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50° C x 30sec. or $<30^{\circ}$ C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100°C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.		Data Sheet No.
Tentative Product	*****	****		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/07/2023	Rev. 1	Page 16/17



Revise History

Rev.	Descriptions	Date	Page
1		07/07/2023	

Official Product	HT Part No. B3CQ3RBG-02DX001H4U1930	Customer Part No.		Data Sheet No.
Tentative Product	*****	****		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/07/2023	Rev. 1	Page 17/17